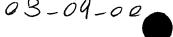


03-09-00





PATENT APPLICATION

Assistant Commissioner for Patents Box Patent Application Washington, D. C. 20231

Sir:

Enclosed herewith for filing is the following utility patent application:

Applicants:

Hamid Noorbakhsh, Siamak Salimian, Paul Luscher, James D. Carducci, Evans Lee, Kaushik

Vaidya, Hongqing Shan, Michael D. Welch

Title of application: TEMPERATURE CONTROLLED SEMICONDUCTOR

PROCESSING CHAMBER LINER

Pages of specification: 23 (including 5 pages of claims and

1 page of abstract)

Sheets of drawing: 9

Executed on: 3/7/2000Docket No.: 4150

mata ¹	PATENT APPLIC No. Filed	CATION I Less	FILING FEE CALCUL Rate/Claim	ATION <u>Fee</u>
Total Claims	36	-20	16 x \$18.00	\$288.00
Independent Claims	5	-3	2 x \$78.00	<u>\$156.00</u>
	Minim	um Fili	ng Fee	\$690.00
			endency Fee le - \$270.00)	\$
	(Independe Corporati Concern)	nt Inve on, or - appro	Small Entity ntor, Non-profit Small Business priate nt attached	\$

TOTAL FILING FEE

\$1134.00

Kindly charge the entire and/or any additional filing fee, as appropriate, to deposit account number 50-1074. To facilitate that charge, a duplicate copy of this letter is enclosed herewith.

Please direct all correspondence to:

Patent Counsel Applied Materials, Inc. 3050 Bowers Avenue P.O. Box 450A Santa Clara, CA 95052

Also enclosed herewith for filing in connection with the enclosed application are:

<pre>Oath;Declaration and Power of Attorney;Disclosure Statement;Letter referencing previously filed disclosure</pre>
A certified copy of a patent application or inventor's certificate, filed and serial no, upon which a claim to priority is made;
Respectfully submitted, Robert W. Mulcahy, Attorney Reg. No. 25,436
EXPRESS MAIL CERTIFICATION
"Express Mail" mailing label number: <u>EL3569/6697US</u> Date of deposit: <u>3H/2000</u>
I hereby certify that this patent application and related papers is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 3 CFR 1.10 on the date indicated above and is addressed to the Assistant Commissioner for Patents, Box Patent Application, Washington, D.C. 20231. Signature of person mailing paper or fee
Name of person mailing paper or fee